

ISD S.A. *Integrated Systems Development*



Introduction to ISD

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ISD Overview

- ❏ Societe Anonyme (S.A.) established in 19/3/1998
- ❏ Independent Organization
- ❏ Place of Business: 32, Kifisias Ave, Atrina Center, Building B, 15125 Maroussi, Greece, Heraklion, Crete, Greece and Grenoble, France.
- ❏ Low Overhead, Flexible TQM Structure
- ❏ ISO Certified
- ❏ R & D Organization
- ❏ Active collaboration with system development companies, software houses and IC manufacturers
- ❏ Dedicated to create innovative and practical solutions using state of the art computer HW and SW components and tools.
- ❏ Offers a complete design service from initial concept through rapid prototyping to production
- ❏ Supports customer products through their life cycle and is in liaison with the customers in-house teams



Expertise and Capabilities



System Level

- Real time critical systems
- System-C based modeling for Architecture Definition, Dimensioning, SW/HW partitioning and Validation/Verification
- System Integration and Validation



Integrated Circuits

- Digital Architecture, Digital Design (ASIC and FPGA flow)
- Analog-Digital Mixed-Mode, Analog and RF Design
- Validation/Verification, Design for Testability and Testing



SW and embedded SW

- Device Drivers and RTOS developments
- DSP, Digital Filtering, Audio/Video Algorithms
- Code Optimization, OS-free scheduling
- Validation/Verification



Prototyping and Verification

- Porting of designs and test-benches to Aptix/Emulators/HW accelerators and FPGAs
- Complete system



Design, Simulation and Validation of PCBs

- Evaluation Kits, Validation Boards and Products



Fully Equipped Lab and a Small Assembly Line for populating PCBs, Plastic Electronics and Integrating Systems

- DC/AC electrical measurements
- Population equipment for FR4, Roger and Flex (up to fine line BGA; prototyping, repair and small production)

- ❏ ICs/IPs+SW for consumer electronics
- ❏ ICs/IPs+SW for handheld devices
- ❏ ICs/IPs for wireless modems (UWB, DVB-RCT, 802.11n MIMO, etc)
- ❏ Systems with printable organic electronics
- ❏ Augmented Reality and Security
- ❏ Sensors and Data Fusion
- ❏ SHM for avionics applications
- ❏ Mixed-signal and digital hardened ICs for space applications in 150nm and 65nm hardened European CMOS processes.
 - ❏ Ser/Des
 - ❏ Next generation DSP
 - ❏ High Performance Data Processor
 - ❏ 24bit ADC/DAC
 - ❏ SpF
 - ❏ etc